

Application Serial No. 10/812,639  
Reply to Office Action of July 2, 2007

PATENT  
Docket: CU-3673

**Amendments to the Specification**

*Please replace the first paragraph on page 8 with the following amended paragraph:*

As illustrated in FIG. 1D, the socket 20 is mounted on a mounting board 60 by soldering terminal portions 22d (shown in FIG. 4) of signal contact members 22 and terminal portions 27d of ground contact members 27 in the socket 20 with the pad 61 of the mounting board 60. The structure of the socket 20 is described in detailed below with reference to FIG. 6A through FIG. 6D, and FIG. 7A and FIG. 7B.